April 2013

FGH40T65UPD 650 V, 40 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- · Positive Temperaure Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.65 V(Typ.) @ I_C = 40 A
- 100% of Parts Tested I_{LM(2)}
- High Input Impedance
- Tightened Parameter Distribution
- RoHS Compliant
- Short-circuit Ruggedness > 5us @25°C

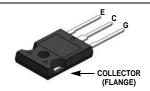
General Description

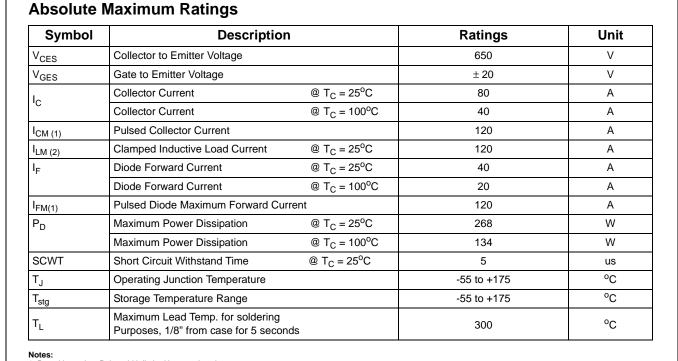
Using innovative field stop trench IGBT technology, Fairchild®'s new series of field stop trench IGBTs offer optimum performance for solar inverter, UPS, welder, and digital power generator where low conduction and switching losses are essential.

Applications

- Solar Inverter, UPS, Welder, Digital Power Generator
- Telecom, ESS







1: Repetitive rating: Pulse width limited by max. junction temperature

2: Ic = 120A, Vce = 400V, Rg = 15Ω

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.56	°C/W
$R_{\theta JC}$ (Diode)	Diode) Thermal Resistance, Junction to Case		1.71	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

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Package Marking and Ordering Information

Device Marking	Device	Package	Æco Status	Packing Type	Qty per Tube
FGH40T65UPD	FGH40T65UPD	TO-247	-	-	30ea

For Fairchild's definition of "green" Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	650	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I_{C} = 40mA, V_{CE} = V_{GE}	4.0	6.0	7.5	V
		I _C = 40A, V _{GE} = 15V	-	1.65	2.3	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 40A, V_{GE} = 15V,$ $T_{C} = 175^{o}C$	-	2.1	-	V
Dvnamic C	Characteristics					
C _{ies}	Input Capacitance		-	2730	3630	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$	-	82	110	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	48	72	pF
Switching	Characteristics			1		
t _{d(on)}	Turn-On Delay Time		-	20	26	ns
t _r	Rise Time		-	26	34	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400V, I_C = 40A, R_G = 7\Omega, V_{GE} = 15V, Q_{CE} = 15V, Q_{CE}$	-	144	187	ns
t _f	Fall Time		-	17	22	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	1.59	2.1	mJ
E _{off}	Turn-Off Switching Loss		-	0.58	0.76	mJ
E _{ts}	Total Switching Loss		-	2.17	2.86	mJ
t _{d(on)}	Turn-On Delay Time		-	19	-	ns
t _r	Rise Time]	-	38	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400V, I_C = 40A,$ $R_G = 7\Omega, V_{GE} = 15V,$	-	153	-	ns
t _f	Fall Time		-	60	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $T_C = 175^{\circ}C$	-	1.84	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.98	-	mJ
E _{ts}	Total Switching Loss		-	2.82	-	mJ
T _{SC}	Short Circuit Withstand Time	V_{GE} = 15V, V_{CC} =400V, R _G = 10 Ω	5	-	-	us

Gate to Emitter Charge

Gate to Collector Charge

Total Gate Charge

Symbol

 Q_{g}

 Q_{ge}

 Q_{gc}

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Electrical Characteristics of the IGBT (Continued)

Parameter

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.1	2.7	V
			T _C = 175 ^o C	-	1.9	-	
E _{rec}	Reverse Recovery Energy		T _C = 175 ^o C	-	96	-	uJ
t _{rr}	Diode Reverse Recovery Time	I _F = 20A, dI _F /dt = 200A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	33	43	ns
·rr		$F = 20A, 0F/01 = 200A/\mu S$	T _C = 175 ^o C	-	128	-	
Q _{rr} Diode Reverse Recovery	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	53	74	nC
~"	Didde Hovered Houdvery Charge		$T_{\rm C} = 175^{\rm o}{\rm C}$	-	341	-	

Test Conditions

 $\begin{array}{l} \mathsf{V}_{\mathsf{CE}} = 400\mathsf{V}, \ \mathsf{I}_{\mathsf{C}} = 40\mathsf{A}, \\ \mathsf{V}_{\mathsf{GE}} = 15\mathsf{V} \end{array}$

Min.

-

-

-

Тур.

177

23

100

Max

265

35

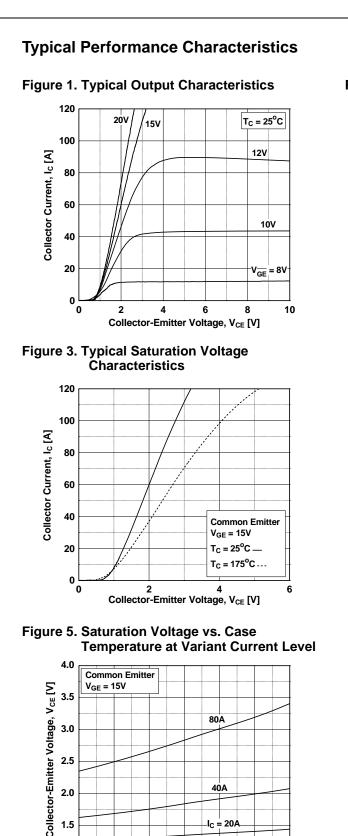
150

Unit

nC

nC

nC



40A

I_C = 20A

125

150

175

100

Collector-EmitterCase Temperature, T_C [°C]

Figure 2. Typical Output Characteristics

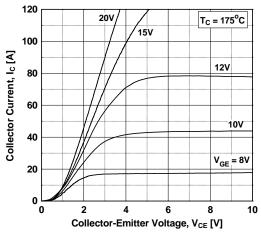
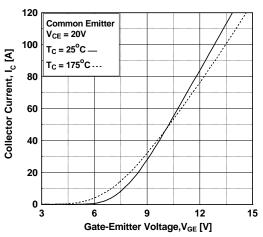
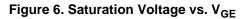
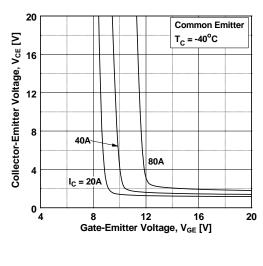


Figure 4. Transfer Characteristics







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50

75

2.0

1.5

1.0

25

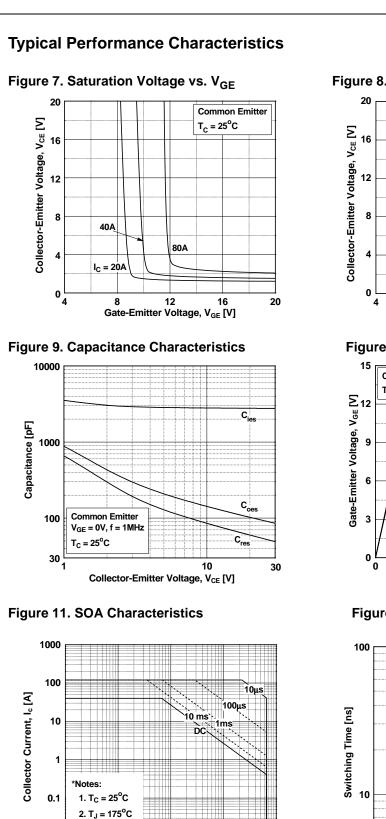


Figure 8. Saturation Voltage vs. V_{GE}

40A

Common Emitter

 $T_{C} = 175^{\circ}C$

80A

= 204 8 20 12 16 Gate-Emitter Voltage, V_{GE} [V] Figure 10. Gate charge Characteristics Common Emitter $T_C = 25^{\circ}C$ 200V 300V 400V ۷_{cc}

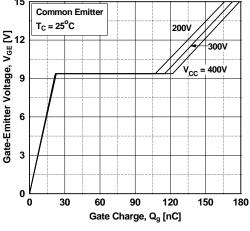
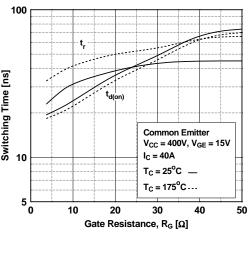


Figure 12. Turn-on Characteristics vs. **Gate Resistance**



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3. Single Pulse

1

10

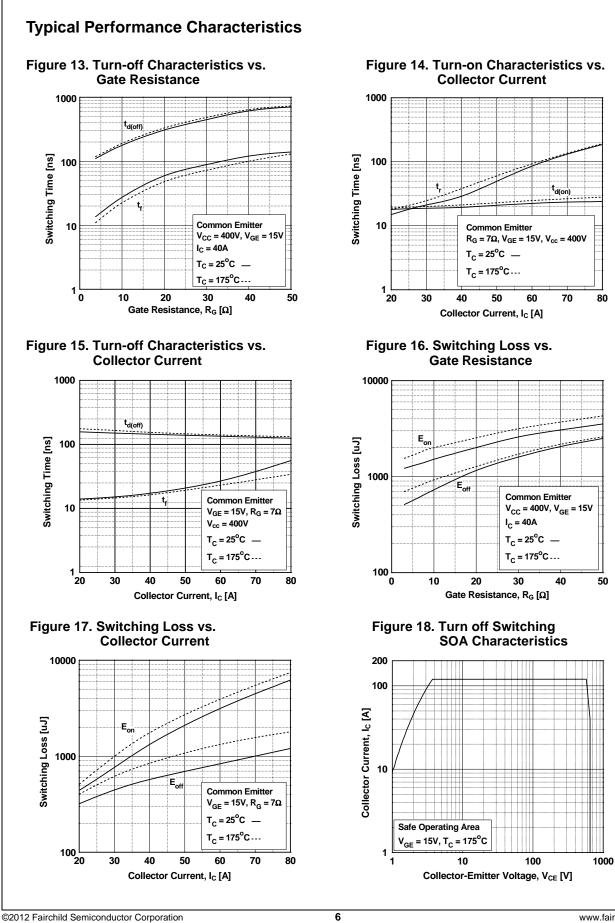
Collector-Emitter Voltage, V_{CE} [V]

100

1000

0.01 . 0.1

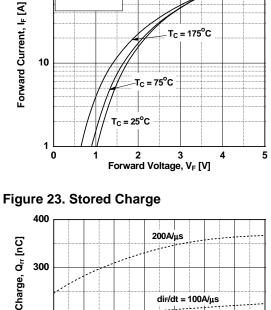




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Typical Performance Characteristics Figure 19. Current Derating 90 Collector Current, Ic[A] Collector Current, I_c [A] 60 30 0 L 0 25 50 75 100 125 150 175 200 Case temperature, T_c [°C] **Figure 21. Forward Characteristics** 200 $T_C = 25^{\circ}C$ 100 T_C = 75°C T_C = 175°C



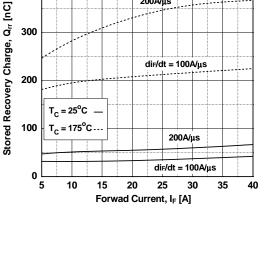


Figure 20. Load Current Vs. Frequence

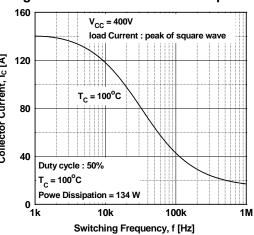


Figure 22. Reverse Recovery Current

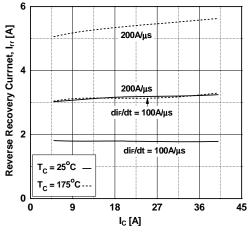
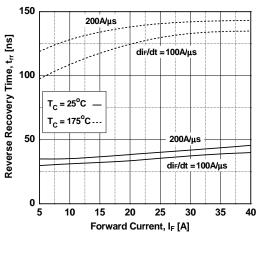
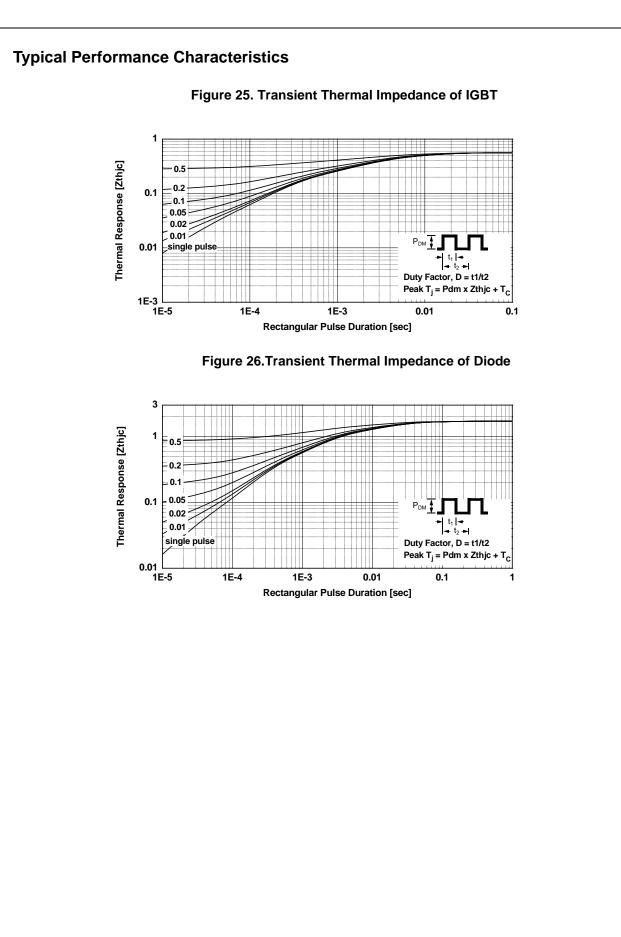


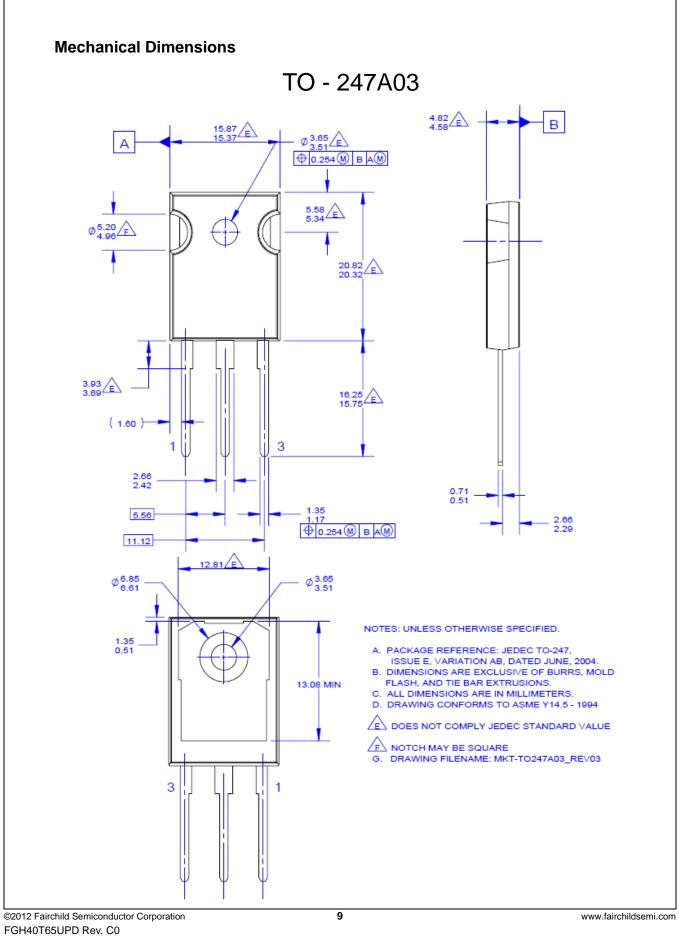
Figure 24. Reverse Recovery Time



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